

### GENERAL DESCRIPTION

The 843S06 is a low voltage, low skew 3.3V LVPECL Clock Synthesizer. The device targets clock distribution in SDH/SONET telecommunication systems but is well suited for a wide range of applications requiring high performance high-speed clock synthesis.

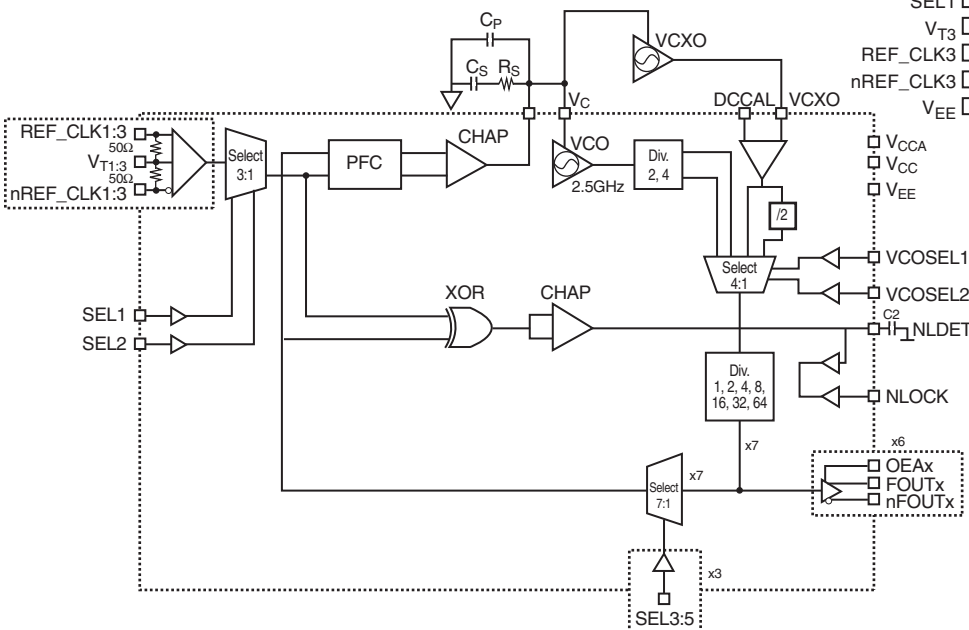
The device implements a fully integrated multiplying PLL including:

- An on-chip analog voltage controlled oscillator (VCO)
- Phase-frequency detector
- Programmable frequency dividers (prescalers)

The loop filter is external in order to optimize the PLL for different applications.

As an option, the 843S06 may be operated with an external voltage controlled crystal oscillator for applications demanding a high-Q oscillator.

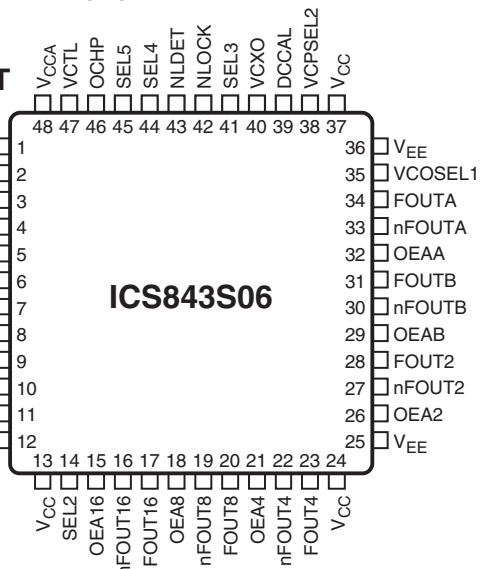
### BLOCK DIAGRAM



### FEATURES

- Six differential 3.3V LVPECL outputs
  - 1,244.16/622.08MHz; 1,244.16/622.08MHz
  - 622.08/311.04MHz; 311.04/155.52MHz
  - 155.52/77.76MHz; 77.76/38.88MHz
- Three selectable differential reference clock inputs  
Clock frequency range: 19MHz to 622MHz
- REF\_CLKx, nREF\_CLKx pairs can accept the following differential input level: LVPECL
- Intrinsic jitter: 0.017mUI<sub>RMS</sub> @ 622MHz
- Output skew: 200ps (maximum)
- Optional external VCXO possible
- Simple external loop filter
- Lock detect output signal
- Full 3.3V operating supply
- Low power operation 0.6W (typical)
- -40°C to 85°C ambient operating temperature
- Lead-free (RoHS 6) packaging

### PIN ASSIGNMENT



**48-Lead TQFP, E-Pad**  
7mm x 7mm x 1.0mm  
package body  
**Y Package**  
Top View

## FEATURES

The 843S06 comprises:

- a low-noise analog VCO
- a Phase-Frequency Detector
- frequency dividers (prescalers)
- a charge pump

into an integrated PLL frequency synthesizer. Careful design and layout matching ensures short delay and minimum skew between input reference clocks and outputs.

## JITTER PERFORMANCE

The frequency of the input reference clock may range between 19.44MHz and 622.08MHz. Since changing the reference frequency alters the loop-gain within the PLL it may be necessary to adjust the loop-filter components when switching to a different reference frequency in order to achieve ITU-T recommended performance.

## PLL PROPAGATION DELAY

When the PLL is in lock, the Phase Frequency Detector aligns the positive (low to high transition) flanks of the reference clock and divided VCO clock on its inputs. These inputs are marked R and V on *Figure 1*. This means the positive transition of any FOUTx output clock is aligned with the positive transition of the reference clock under the condition of equal reference clock frequency and FOUTx output frequency, please refer to *Figure 3*. *Figure 3* defines the PLL propagation delay parameter ( $D_{OUT}$ ). Note that  $D_{OUT}$  will change with leakage currents drawn from the loop-filter, hence  $D_{OUT}$  is loop-filter dependant.

*Figure 3* is an example for  $D_{OUT}$  phase relationships. The REF\_CLK[1:3] input signals shown are in reference to FOUT2 output signals, both running at Fx MHz with the PLL locked using the recommended loop-filter and no excessive leakage current drawn from the charge pump output. A skew of 200ps maximum is expected, (see *Figure 4*). Skew over supply and temperature definitions are at any combination of extremes. The expected skew values are only valid with the PLL locked when using the recommended loop-filter. The Total Output Uncertainty is  $D_{OUT} + t_{skew}$  (see *Figures 3* and *4*).

## OUTPUT CLOCKS

The 843S06 is equipped with six LVPECL compatible output buffers. Each of the output buffers is equipped with an LVTTTL enable pin that may be used to disable clock signals not in use for noise reduction. Clock outputs are synchronized by the falling edge. The phases of the clock output signals are aligned with less than 200ps skew peak-to-peak between any two clock signals. Available clock signals from the PLL are divide by 1 (signal FOUTA and by FOUTB), divide by 2 (FOUT2), divide by 4 (FOUT4), divide by 8 (FOUT8) and divide by 16 (FOUT16).

## LOCK DETECT

The device outputs a signal NLDET that may be used to signal whether or not the PLL is locked thus allowing fault diagnostics. The NLDET outputs the result of an XOR operation of the signals input to the phase-frequency detector. To be useful, this signal must be filtered by a capacitor. The recommended value of this capacitor is 10nF. The filtered lock-detect signal is output as an LVTTTL compatible signal on the output NLOCK via a comparator.

## PLL LOOP-FILTER

It has been chosen to locate the passive loop-filter components externally to the device. This allows for easy optimization of the loop-filter to different applications. The recommended loop-filter is a simple first-order RC-Circuit as shown on *Figure 1*, resulting in a second order, type 2 loop.

The values of  $R_s$ ,  $C_s$  and  $C_p$  depend on the application. With respect to ITU-T recommended jitter performance, appropriate values for  $R_s$ ,  $C_s$  and  $C_p$  have been determined to be  $R_s = 3.92k\Omega$ ,  $C_s = 0.22\mu F$ , and  $C_p = 1pF$  for input frequency of 155.52MHz; and  $R_s = 9.09k\Omega$ ,  $C_s = 0.01\mu F$ , and  $C_p = 0$  for input frequency of 19.44MHz.

Note that the loop-filter should be terminated to the negative VCO supply. An external VCXO might require a different termination point for lowest point.

## CHARGE PUMP POLARITY

When the PLL increases the VCO frequency, the charge pump pin OCHP sinks current. That is, the voltage on the loop-filter capacitor drops to increase the oscillator frequency. So be aware, that an external VCO must have a negative VCO constant in order to achieve a stable lock.

## ON-CHIP VCO POWER DOWN

When operated with an external VCXO the on-chip VCO should be powered down for noise reduction. This is done by leaving  $V_{CCA}$  open. See  $V_{CCA}$  pin description.

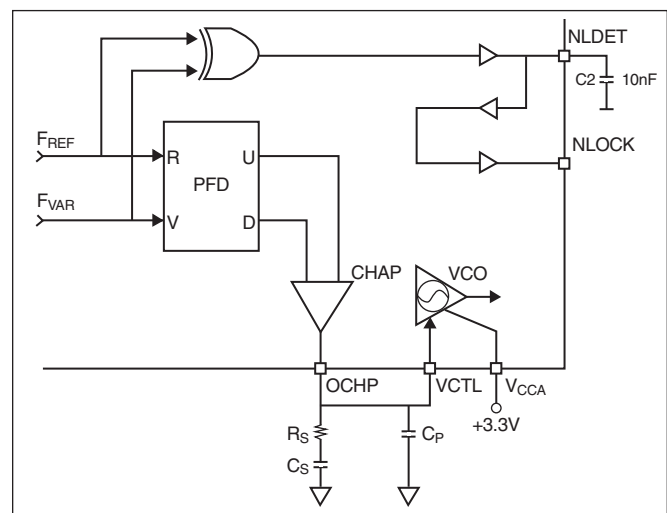


FIGURE 1. APPLICATION DIAGRAM

**TABLE 1. INPUT REFERENCE FREQUENCIES AS FUNCTION OF SEL[3:5] SETTINGS**

| VCO Source and Corresponding VCOSEL[1:2] Settings |      | FOUTA | Input Reference Frequency (CKREFx [MHz]) and Corresponding SEL[3:5] Settings |         |         |         |         |         |            |                     |
|---------------------------------------------------|------|-------|------------------------------------------------------------------------------|---------|---------|---------|---------|---------|------------|---------------------|
|                                                   |      |       | MHz                                                                          | 0, 0, 0 | 0, 0, 1 | 0, 1, 0 | 0, 1, 1 | 1, 0, 0 | 1, 0, 1    | 1, 1, 0             |
| Internal VCO                                      | 0, 1 | 622   | 622                                                                          | 311     | 155     | 78      | 39      | 19      | N/A<br>9.7 | Disable<br>Feedback |
| Ext. VCO: 1244MHz                                 | 0, 0 |       |                                                                              |         |         |         |         |         |            |                     |
| Ext. VCO: 622MHz                                  | 1, 1 |       |                                                                              |         |         |         |         |         |            |                     |
| Internal VCO                                      | 1, 0 | 1244  | N/A<br>1244                                                                  | 622     | 311     | 155     | 78      | 39      | 19         |                     |
| Ext. VCO: 2488MHz                                 | 0, 0 |       |                                                                              |         |         |         |         |         |            |                     |
| Ext. VCO: 1244MHz                                 | 1, 1 |       |                                                                              |         |         |         |         |         |            |                     |

### PRESCALER SETTINGS

For the PLL to achieve lock a proper relation must exist between the input reference frequency and the setting of the on-chip prescalers. The prescalers are set by signals: VCOSEL1, VCOSEL2, SEL3, SEL4, and SEL5 (refer to Table 1).

First, determine the desired master output frequency. This is the frequency of output clock FOUTA (FOUTA is mirrored by FOUTB). Next, select whether the oscillator is external or internal. The VCO source can be external (622, 1244 or 2488MHz) or internal (2488MHz). Table 1 gives the value of VCOSEL1/2. Finally, the proper relation between the reference clock frequency and the setting of SEL3, SEL4, SEL5 is read from Table 1.

### DUTY CYCLE CALIBRATION

When operated with an external oscillator, the differential LVPECL inputs (VCXO and DCCAL) are to be used. In single-ended operation the duty cycle of the outputs FOUTA and FOUTB may be adjusted by tuning the voltage on DCCAL.

TABLE 2. PIN DESCRIPTIONS

| Number                 | Name                                | Type       |              | Description                                                                                                                                                   |
|------------------------|-------------------------------------|------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 12, 25, 36          | $V_{EE}$                            | Power      |              | Negative supply pins.                                                                                                                                         |
| 2                      | REF_CLK1                            | LVPECL IN  |              | Non-inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T1}$ . See Figure 2, Termination of REF_CLKx. See Table 6.              |
| 3                      | nREF_CLK1                           | LVPECL IN  |              | Inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T1}$ . See Figure 2, Termination of REF_CLKx. See Table 6.                  |
| 4                      | $V_{T1}$                            | Bias       |              | Termination input. Common termination point of 2 x 50 $\Omega$ resistors, internally biased to 2V. $Z_{IN,VT1} = 1k\Omega$ .                                  |
| 5                      | $V_{T2}$                            | Bias       |              | Termination input. Common termination point of 2 x 50 $\Omega$ resistors, internally biased to 2V. $Z_{IN,VT2} = 1k\Omega$ .                                  |
| 6                      | REF_CLK2                            | LVPECL IN  |              | Non-inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T2}$ . See Figure 2, Termination of REF_CLKx. See Table 6.              |
| 7                      | nREF_CLK2                           | LVPECL IN  |              | Inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T2}$ . See Figure 2, Termination of REF_CLKx. See Table 6.                  |
| 8, 14                  | SEL1, SEL2                          | LVT IN     | Pullup Note1 | Reference clock select inputs. See Table 3A. LVTTTL interface levels.                                                                                         |
| 9                      | $V_{T3}$                            | Bias       |              | Termination input. Common termination point of 2 x 50 $\Omega$ resistors, internally biased to 2V. $Z_{IN,VT3} = 1k\Omega$ .                                  |
| 10                     | REF_CLK3                            | LVPECL IN  |              | Non-inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T3}$ . See Figure 2, Termination of REF_CLKx. See Table 6.              |
| 11                     | nREF_CLK3                           | LVPECL IN  |              | Inverting differential reference clock input. $R_T = 50\Omega$ termination to $V_{T3}$ . See Figure 2, Termination of REF_CLKx. See Table 6.                  |
| 13, 24, 37             | $V_{CC}$                            | Power      |              | Core supply pins.                                                                                                                                             |
| 15, 18, 21, 26, 29, 32 | OEA16, OEA8, OEA4, OEA2, OEAB, OEAA | LVT IN     | Pullup Note1 | Output enable pins. When HIGH (default), the FOUTx output is enabled. When LOW, the FOUTx output is disabled. 16k $\Omega$ resistor. LVTTTL interface levels. |
| 16, 17                 | nFOUT16, FOUT16                     | LVPECL OUT |              | Differential clock output pair ( $\pm$ 16). LVPECL interface levels.                                                                                          |
| 19, 20                 | nFOUT8, FOUT8                       | LVPECL OUT |              | Differential clock output pair ( $\pm$ 8). LVPECL interface levels.                                                                                           |
| 22, 23                 | nFOUT4, FOUT4                       | LVPECL OUT |              | Differential clock output pair ( $\pm$ 4). LVPECL interface levels.                                                                                           |
| 27, 28                 | nFOUT2, FOUT2                       | LVPECL OUT |              | Differential clock output pair ( $\pm$ 2). LVPECL interface levels.                                                                                           |
| 30, 31                 | nFOUTB, FOUTB                       | LVPECL OUT |              | Differential clock output pair ( $\pm$ 1). LVPECL interface levels.                                                                                           |
| 33, 34                 | nFOUTA, FOUTA                       | LVPECL OUT |              | Differential clock output pair ( $\pm$ 1). LVPECL interface levels.                                                                                           |
| 35, 38                 | VCOSSEL1, VCOSSEL2                  | LVT IN     | Pullup Note1 | Select pins for internal or external oscillator and prescale. See Table 4B. 16k $\Omega$ resistor. LVTTTL interface levels.                                   |

NOTE 1: Pullup refers to internal pullup resistors. See Table 2, Pin Characteristics Table, for typical values.  
Continued on next page.

**TABLE 2. PIN DESCRIPTIONS, CONTINUED**

| Number     | Name             | Type       |              | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|------------|------------------|------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 39, 40     | DCCAL, VCXO      | LVT IN     |              | Differential external clock input, $F_{MAX} = 2.7\text{GHz}/1.35\text{GHz}$ . The input can be used differentially or the DCCAL input may be used as a VCXO duty cycle control. When selecting external VCXO (divide by 1) the duty cycle of the FOUTA/B, nFOUTA/B outputs can be controlled by DCCAL. Adjust range: 40/60 to 60/40 assuming sinusoidal input at VCXO. DCCAL is connected to the inverted input.<br>NOTE: Pins DCCAL (pin 39) and VCXO (pin 40) can handle ESD, HBM of maximum value: 500V. |
| 41, 44, 45 | SEL3, SEL4, SEL5 | LVT IN     | Pullup Note1 | Prescaler select inputs. See Table 4C. LVTTTL interface levels.                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 42         | NLOCK            | LVT OUT    |              | Lock detect buffered. When 10nF is connected to NLDET, then NLOCK = 0 signals PLL in-lock; NLOCK = 1 signals PLL out-of-lock. See Note 2.                                                                                                                                                                                                                                                                                                                                                                   |
| 43         | NLDET            | Analog OUT |              | Lock detect unfiltered. Connect pin to a 10nF capacitor to ground.                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 46         | OCHP             | Analog OUT |              | Charge pump output to be connected to the loop filter. The pin will sink current to increase the oscillator frequency and source current to decrease the oscillator frequency. Refer to Figure 1.                                                                                                                                                                                                                                                                                                           |
| 47         | VCTL             | Analog IN  |              | Voltage control pin for internal VCO. To be connected to the loop filter.                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 48         | $V_{CCA}$        | Power      |              | Internal VCO analog supply pin. Leave open when using external VCO.                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|            | Heat sink        | Power      |              | Heatsink is electrically isolated from the internal device and is attached facing down.                                                                                                                                                                                                                                                                                                                                                                                                                     |

NOTE 1: *Pullup* refers to internal pullup resistors. See Table 2, Pin Characteristics Table, for typical values.

NOTE 2: Refer to the Application Note on page 15.

**TABLE 3. PIN CHARACTERISTICS**

| Symbol       | Parameter             | Test Conditions | Minimum | Typical | Maximum | Units      |
|--------------|-----------------------|-----------------|---------|---------|---------|------------|
| $C_{IN}$     | Input Capacitance     |                 |         | 4       |         | pF         |
| $R_{PULLUP}$ | Input Pullup Resistor |                 |         | 16      |         | k $\Omega$ |

TABLE 4A. CONTROL INPUT FUNCTION TABLE

| Input Select |      | Input Clock                         |
|--------------|------|-------------------------------------|
| SEL1         | SEL2 |                                     |
| 0            | 0    | REF_CLK1                            |
| 0            | 1    | REF_CLK2                            |
| 1            | 0    | REF_CLK3                            |
| 1            | 1    | No input reference to PLL (default) |

TABLE 4B. VCOSEL INPUT FUNCTION TABLE

| Input Select |         | Input Clock                                                        |
|--------------|---------|--------------------------------------------------------------------|
| VCOSEL1      | VCOSEL2 |                                                                    |
| 0            | 0       | External VCXO, $\div 2$ , ( $F_{MAX} = 2.7\text{GHz}$ )            |
| 0            | 1       | Internal VCO, $F_{NOM} = 622\text{MHz}$                            |
| 1            | 0       | Internal VCO, $F_{NOM} = 1.244\text{MHz}$                          |
| 1            | 1       | External VCXO, $\div 1$ , ( $F_{MAX} = 1.35\text{GHz}$ ) (default) |

TABLE 4C. OUTPUT DIVIDER SELECT FUNCTION TABLE

| Input Select |      |      | Input Divider                         | $V_{TNOM}$<br>Frequency (MHz) |
|--------------|------|------|---------------------------------------|-------------------------------|
| SEL3         | SEL4 | SEL5 |                                       |                               |
| 0            | 0    | 0    | $\div 1$                              | 622                           |
| 0            | 0    | 1    | $\div 2$                              | 622 - 311                     |
| 0            | 1    | 0    | $\div 4$                              | 311 - 155                     |
| 0            | 1    | 1    | $\div 8$                              | 155 - 78                      |
| 1            | 0    | 0    | $\div 16$                             | 78 - 39                       |
| 1            | 0    | 1    | $\div 32$                             | 39 - 19                       |
| 1            | 1    | 0    | $\div 64$                             | 19                            |
| 1            | 1    | 1    | No feedback to PLL from VCO (default) |                               |

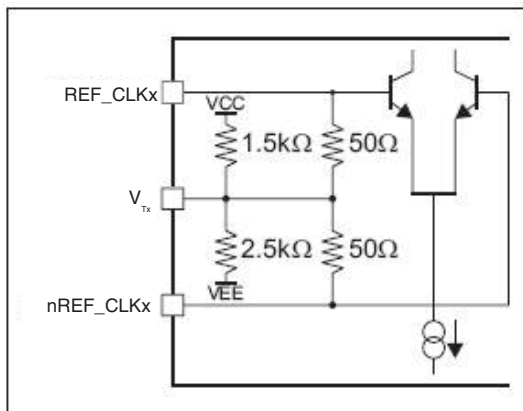


FIGURE 2. TERMINATION OF REF\_CLKx INPUTS

**ABSOLUTE MAXIMUM RATINGS**

|                                          |                          |
|------------------------------------------|--------------------------|
| Supply Voltage, $V_{CC}, V_{CCA}$        | -0.5V to 4.0V            |
| Input Voltage, $V_I$                     | -0.5V to $V_{CC} + 0.5V$ |
| Input Current, $I_I$                     | -1.0mA to 1.0mA          |
| Output Voltage, $V_O$                    | -0.5V to $V_{CC}$        |
| Output Current, $I_O$                    |                          |
| Continuous Current                       | 50mA                     |
| Surge Current                            | 100mA                    |
| Package Thermal Impedance, $\theta_{JC}$ | 5°C/W                    |
| Operating Temperature, $T_J$             | -40°C to 125°C           |
| Storage Temperature, $T_{STG}$           | -65°C to 125°C           |
| Electrostatic Discharge Voltage, ESD     |                          |
| HBM (Note1, 2)                           | 1000V max.               |
| CDM (Note 3)                             | 50V max.                 |

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

NOTE 1: Human Body Model tested to JESD22-A114-D

NOTE 2: Pins DCCAL (pin 39) and VCXO (pin 40) can handle ESD, HBM of maximum value: 500V

NOTE 3: Charge Device Model tested to JESD2-C101

**TABLE 5A. POWER SUPPLY DC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$** 

| Symbol    | Parameter             | Test Conditions           | Minimum         | Typical | Maximum  | Units |
|-----------|-----------------------|---------------------------|-----------------|---------|----------|-------|
| $V_{CC}$  | Power Supply Voltage  |                           | 3.135           | 3.3     | 3.465    | V     |
| $V_{CCA}$ | Analog Supply Voltage |                           | $V_{CC} - 0.08$ | 3.3     | $V_{CC}$ | V     |
| $I_{CC}$  | Power Supply Current  | Outputs Unloaded (Note 1) |                 | 165     | 206.5    | mA    |
| $I_{CCA}$ | Analog Supply Current |                           |                 |         | 8        | mA    |

NOTE 1: Refer to Power Considerations on page 16.

**TABLE 5B. LVCMOS/LVTTL DC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$** 

| Symbol     | Parameter                             | Test Conditions                                                                                     | Minimum | Typical | Maximum        | Units   |
|------------|---------------------------------------|-----------------------------------------------------------------------------------------------------|---------|---------|----------------|---------|
| $V_{IH}$   | Input High Voltage                    |                                                                                                     | 2       |         | $V_{CC} + 0.3$ | V       |
| $V_{IL}$   | Input Low Voltage                     |                                                                                                     | -0.3    |         | 0.8            | V       |
| $I_{IH}$   | Input High Current; NOTE 1            | SEL1:SEL5, VCOSEL1, VCOSEL2, OEAA, OEAB, OEA2, OEA4, OENA8, OEA16<br>$V_{CC} = V_{IN} = 3.465V$     |         |         | 200            | $\mu A$ |
| $I_{IL}$   | Input Low Current; NOTE 1             | SEL1:SEL5, VCOSEL1, VCOSEL2, OEAA, OEAB, OEA2, OEA4, OENA8, OEA16<br>$V_{CC} = 3.465V, V_{IN} = 0V$ | -500    |         |                | $\mu A$ |
| $V_{OL}$   | Output Low Voltage                    | $I_{OL} = -1mA$                                                                                     | 0       |         | 0.4            | V       |
| $V_{OH}$   | Output High Voltage                   | $I_{OH} = 3mA$                                                                                      | 2.1     |         | $V_{CC}$       | V       |
| $V_{REF}$  | Internal LVT Reference                |                                                                                                     | 1.33    | 1.4     | 1.54           | V       |
| $I_{OCHP}$ | Charge Pump Output Current; NOTE 1    |                                                                                                     | -155    |         | 155            | $\mu A$ |
| $V_{OCHP}$ | Charge Pump Output Voltage; NOTE 1, 2 |                                                                                                     | 0.3     |         | $V_{CC} - 0.3$ | V       |

NOTE 1: Under the condition of typical supply voltage.

NOTE 2: Assuming a purely capacitive load.

**TABLE 5C. DIFFERENTIAL DC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$** 

| Symbol     | Parameter                             | Test Conditions                | Minimum        | Typical | Maximum         | Units    |
|------------|---------------------------------------|--------------------------------|----------------|---------|-----------------|----------|
| $I_{IH}$   | Input High Current                    | $V_{CC} = V_{IN} = 3.465V$     |                |         | 150             | $\mu A$  |
| $I_{IL}$   | Input Low Current                     | $V_{CC} = 3.465V, V_{IN} = 0V$ | -150           |         |                 | $\mu A$  |
| $V_{PP}$   | Peak-to-Peak Input Voltage; NOTE 1, 2 |                                | 0.15           |         | 1.3             | V        |
| $V_{CMR}$  | Common Mode Input Voltage; NOTE 2, 3  |                                | $V_{EE} + 0.5$ |         | $V_{CC} - 0.85$ | V        |
| $R_{TERM}$ | Internal Termination Resistor         |                                |                | 50      |                 | $\Omega$ |

NOTE 1:  $V_{PP} = V_{REF\_CLK}[1:3] - V_{nREF\_CLK}[1:3]$ .

NOTE 2:  $V_{IL}$  should not be less than -0.3V.

NOTE 3: Common mode voltage is defined as  $V_{IH}$ . Refer to parameter measurement information, *Differential Input Level Diagram* on page 10.

**TABLE 5D. LVPECL DC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$** 

| Symbol      | Parameter                                | Test Conditions | Minimum        | Typical | Maximum        | Units |
|-------------|------------------------------------------|-----------------|----------------|---------|----------------|-------|
| $V_{OH}$    | Output Voltage High; NOTE 1              |                 | $V_{CC} - 1.2$ |         | $V_{CC} - 0.9$ | V     |
| $V_{OL}$    | Output Voltage Low; NOTE 1               |                 | $V_{CC} - 2.0$ |         | $V_{CC} - 1.6$ | V     |
| $V_{SWING}$ | Peak-to-Peak Output Voltage Swing        |                 | 0.6            |         | 1.0            | V     |
| $V_{REF}$   | Internal LVPECL Reference for VCXO Input |                 | 1.8            | 2.0     | 2.2            | V     |

NOTE 1: Outputs terminated with  $50\Omega$  to  $V_{CC} - 2V$ . Refer to Parameter Measurement information, *Output Load AC Test Circuit Drawing* on page 10.



**TABLE 6. AC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$** 

| Symbol          | Parameter                                                                                                          | Test Conditions                  | Minimum | Typical | Maximum | Units              |
|-----------------|--------------------------------------------------------------------------------------------------------------------|----------------------------------|---------|---------|---------|--------------------|
| $f_{VCO}$       | VCO Tuning Range; NOTE 1                                                                                           |                                  | 560     |         | 662     | MHz                |
| $f_{IN}$        | Maximum Input Frequency                                                                                            |                                  | 19      | 622.08  | 662     | MHz                |
| $K_{VCO}$       | VCO Gain Constant                                                                                                  | @ 622MHz                         |         | 187     |         | MHz/V              |
| $J_{INTRINSIC}$ | Intrinsic Jitter; NOTE 2                                                                                           | @ 622MHz<br>Ref. Clock Frequency |         | 0.17    |         | mUI <sub>RMS</sub> |
| $J_{TRANSFER}$  | Jitter Transfer Function; NOTE 3<br>As an example, refer to Figure 5, pg 11                                        | $F_{JITTER} < 2MHz$              |         |         | 0       | dB                 |
|                 |                                                                                                                    | $F_{JITTER} > 2MHz$              |         |         | -20     | dB/dec             |
| $D_{OUT}$       | Output Delay from Ref. Clock (REF_CLKx) to Clock Output (FOUTx); NOTE 6, 8                                         | FOUTA, FOUTB                     | -75     | 75      | 225     | ps                 |
|                 |                                                                                                                    | FOUT2,4,8,16; NOTE 4             | 25      | 175     | 325     | ps                 |
| Duty Cycle      | Output Duty Cycle; NOTE 5<br>Refer to Parameter Measurement Information (Rise/Fall Time), See page 10 for drawing. |                                  | 48      | 50      | 52      | %                  |
| $t_R / t_F$     | LVPECL Output Rise/Fall Time; See page 10 for drawing                                                              | 20% to 80% differential          |         |         | 300     | ps                 |
| $t_{sk(o)}$     | Output Skew; NOTE 7, 8                                                                                             |                                  |         |         | 200     | ps                 |

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

NOTE 1: VCOSEL set to divide by 4.

NOTE 2: Measurement range 12kHz to 20MHz.

NOTE 3: The loop filter is dependent on the frequency of the reference clock signal in order to exceed ITU-T jitter masks.

NOTE 4: Parameter  $D_{OUT}$  is leakage current dependent and only defined when the PLL is locked using the recommended loop filter;  $D_{OUT}$  is only defined for input and output signals of equal frequency.

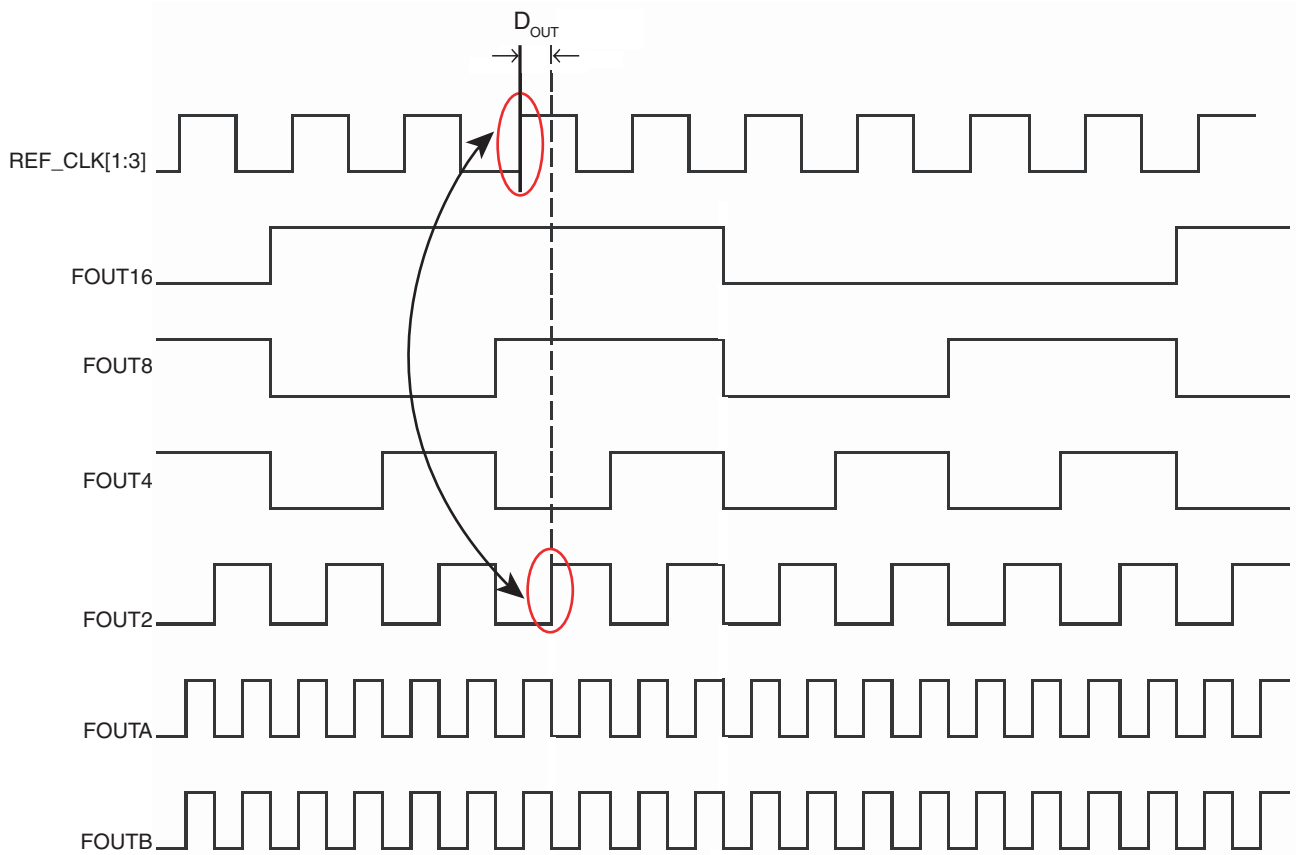
NOTE 5: When external, the VCXO (divide by 1) is selected, DCCAL can be used to obtain the duty cycle requirements.

NOTE 6: Reference Figure 3 on page 10.

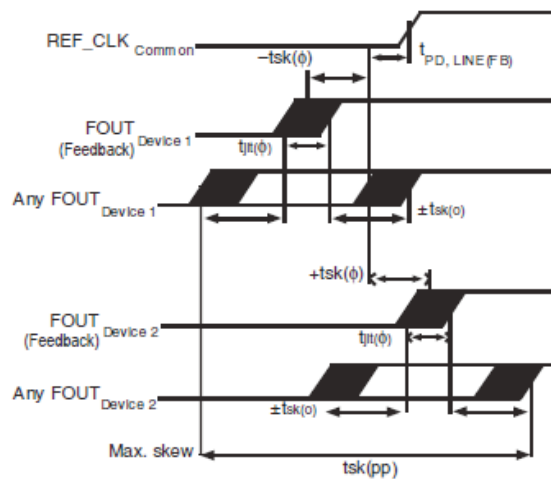
NOTE 7: Output Skew measured from falling edge to falling edge. Refer to page 10.

NOTE 8: See Figure 4 to understand *Total Output Uncertainty*.

## PARAMETER MEASUREMENT INFORMATION

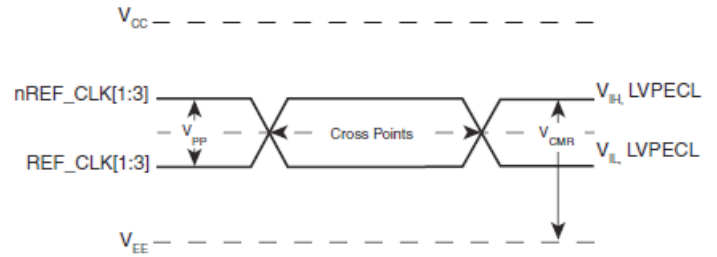
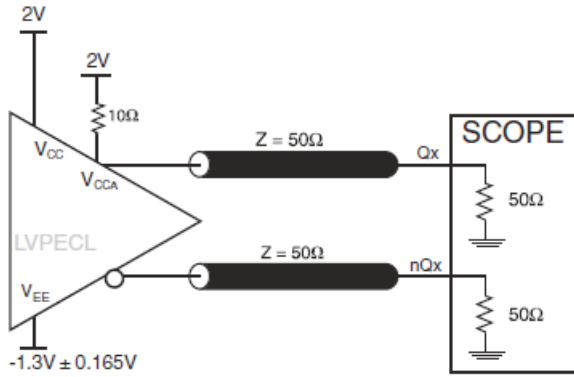


**FIGURE 3. TIMING OF OUTPUT CLOCKS WITH DEFINITION OF OUTPUT DELAY AND PEAK-TO-PEAK SKEW, (SEE NOTE 4 ON PAGE 8)  
(EXAMPLE FOR REF\_CLK TO FOUT2)**



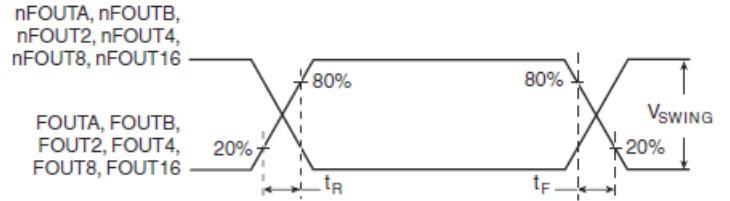
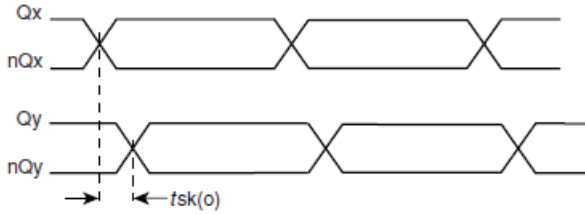
**FIGURE 4. TOTAL OUTPUT UNCERTAINTY**

# PARAMETER MEASUREMENT INFORMATION



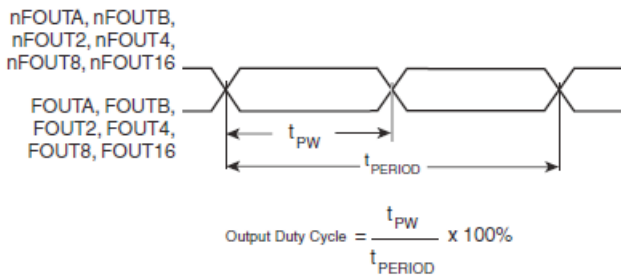
## 3.3V LVPECL OUTPUT LOAD TEST CIRCUIT

## DIFFERENTIAL INPUT LEVEL



## OUTPUT SKEW

## OUTPUT RISE/FALL TIME



## OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

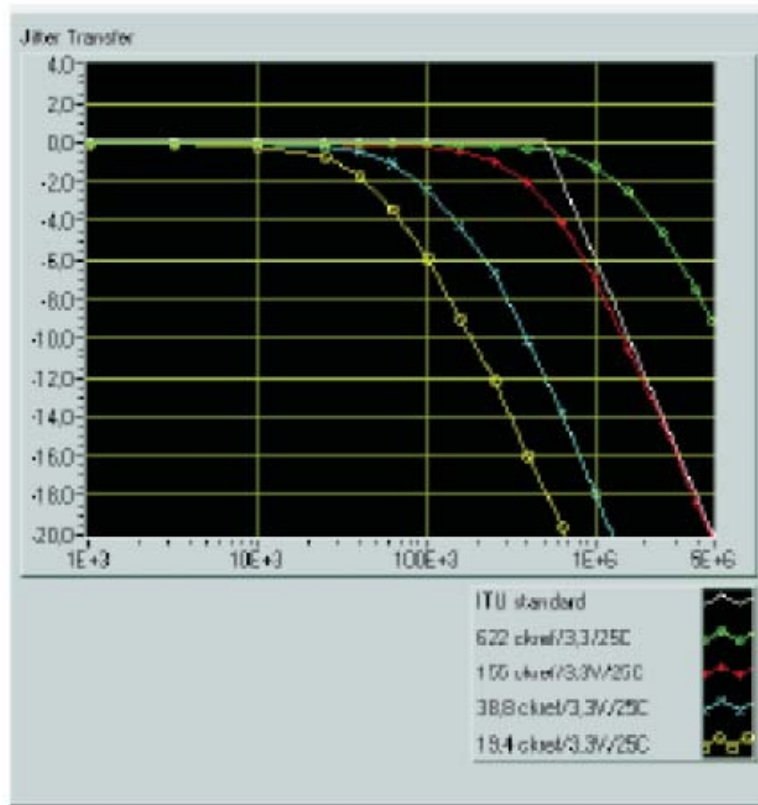


FIGURE 5. EXAMPLE OF JITTER TRANSFER BANDWIDTH VS. REFERENCE CLOCK FREQUENCY

## APPLICATION INFORMATION

### POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. To achieve optimum jitter performance, power supply isolation is required. The 843S06 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL.  $V_{CC}$  and  $V_{CCA}$  should be individually connected to the power supply plane through vias, and  $0.01\mu\text{F}$  bypass capacitors should be used for each pin. *Figure 6* illustrates this for a generic  $V_{CC}$  pin and also shows that  $V_{CCA}$  requires that an additional  $10\Omega$  resistor along with a  $10\mu\text{F}$  bypass capacitor be connected to the  $V_{CCA}$  pin. The  $10\Omega$  resistor can also be replaced by a ferrite bead.

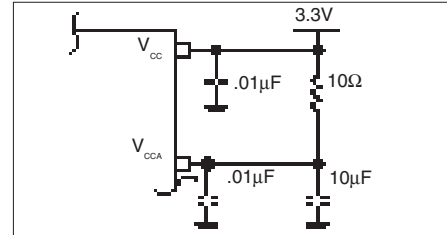


FIGURE 6. POWER SUPPLY FILTERING

### 3.3V DIFFERENTIAL INPUT WITH BUILT-IN $50\Omega$ TERMINATION UNUSED INPUT HANDLING

To prevent oscillation and to reduce noise, it is recommended to have pullup and pulldown connect to true and complement of the unused input as shown in *Figure 7*.

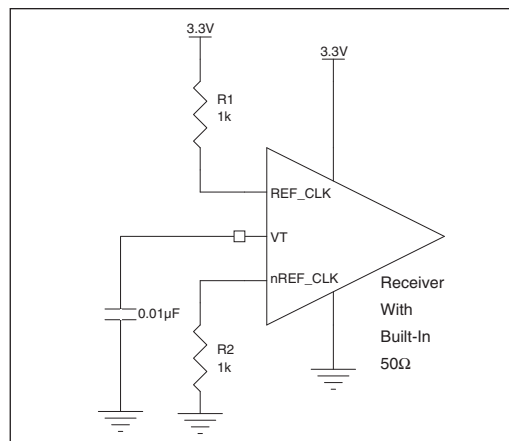


FIGURE 7. UNUSED INPUT HANDLING

## RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

### INPUTS:

#### REF\_CLK/nREF\_CLK INPUTS

For applications not requiring the use of the differential input, both REF\_CLK and nREF\_CLK can be left floating. Though not required, but for additional protection, a 1k $\Omega$  resistor can be tied from REF\_CLK to ground. See Figure 7.

#### LVC MOS/LVTTL CONTROL PINS

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1k $\Omega$  pull-up resistor can be used.

### OUTPUTS:

#### LVPECL OUTPUTS

All unused LVPECL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

## TERMINATION FOR LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive 50 $\Omega$  transmission

lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 8A and 8B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

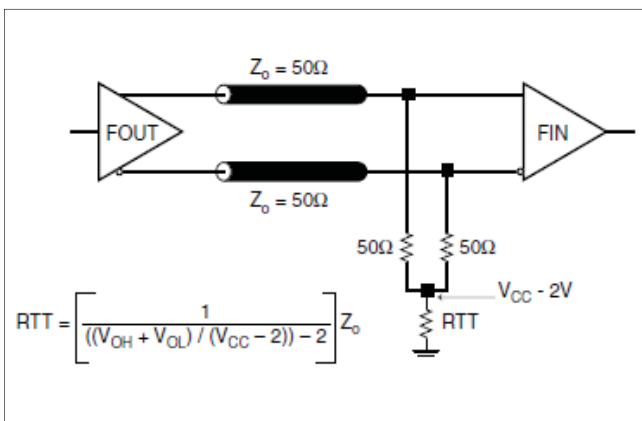


FIGURE 8A. LVPECL OUTPUT TERMINATION

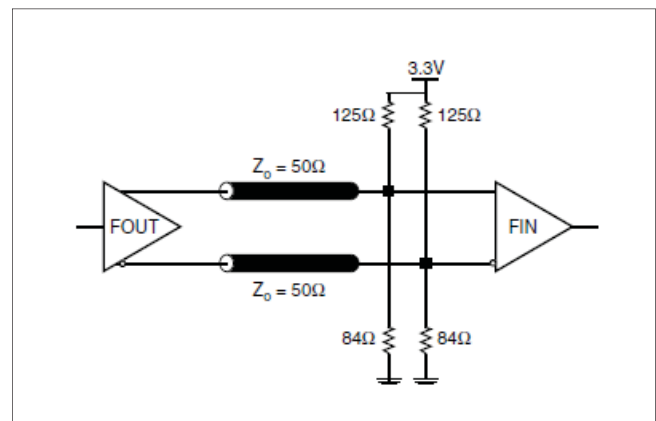


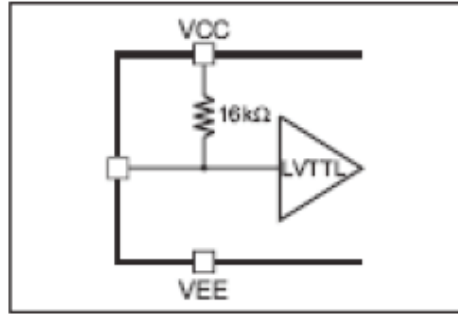
FIGURE 8B. LVPECL OUTPUT TERMINATION

**PRACTICAL CONSIDERATIONS**

When designing the PCB it is important to consider noise issues. Decoupling capacitors should be applied to each supply pin. Output clock lines must be routed as transmission lines.

The reference clock inputs are terminated on-chip by  $50\Omega$  to the positive supply. The termination pins REF\_CLK[1:3] are biased on-chip to 2V. The input impedance seen into REF\_CLK[1:3] equals  $1k\Omega$ .

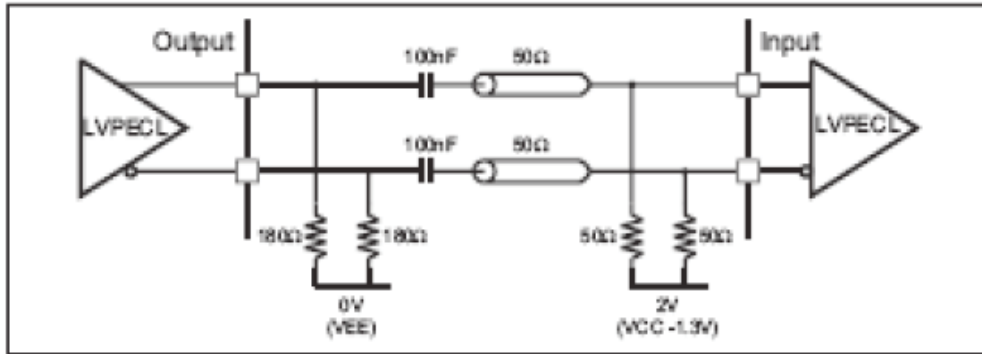
The LVPECL clock outputs are terminated according to Figures 9B and 9C.



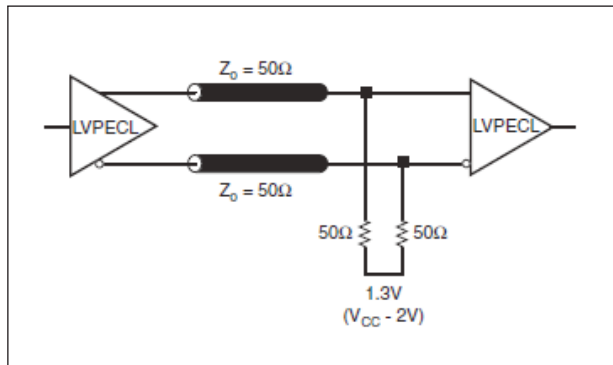
**FIGURE 9A. LVTTTL SELECT PIN**

**NOTE:** See page 13, *Recommendations for Unused Input and Output Pins.*

LVTTTL select pins are terminated on-chip with a  $16k\Omega$  pull-up resistor giving a logic “1” when not connected.



**FIGURE 9B. LVPECL OUTPUT TERMINATION, AC-COUPLED**



**FIGURE 9C. LVPECL OUTPUT TERMINATION, DC-COUPLED**

**Application Note:** IDT will provide an application note to allow the end-user to approximate the maximum time delay for NLock to be triggered when:

Within VCXO tuning range, the 843S06 will track VCXO rate of change according to bandwidth curve of PLL.

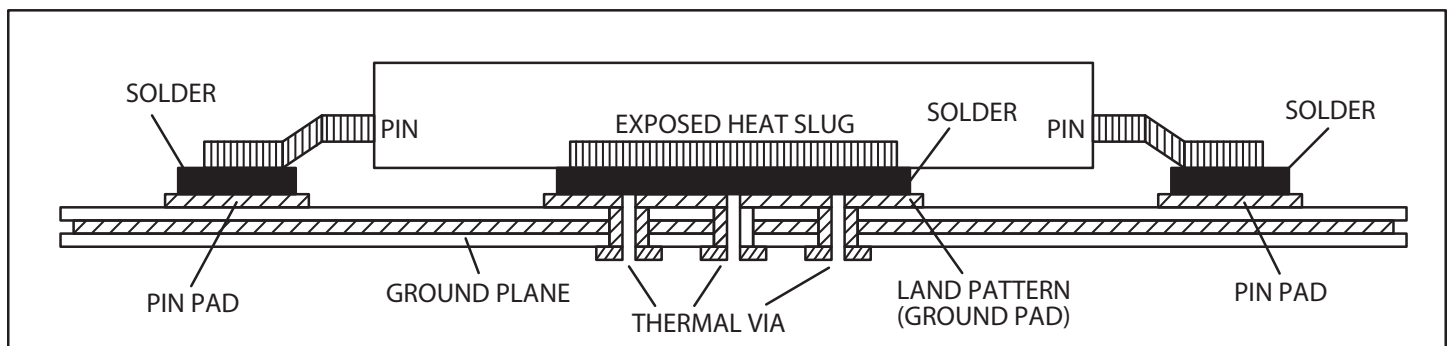
Outside of VCXO tuning range, the 843S06 will trigger NLOCK with a maximum time delay based on rate of change of input and time delay of NLOCK trigger mechanism (including noise immunity mechanism).

## EPAD THERMAL RELEASE PATH

In order to maximize both the removal of heat from the package and the electrical performance, a land pattern must be incorporated on the Printed Circuit Board (PCB) within the footprint of the package corresponding to the exposed metal pad or exposed heat slug on the package, as shown in *Figure 10*. The solderable area on the PCB, as defined by the solder mask, should be at least the same size/shape as the exposed pad/slug area on the package to maximize the thermal/electrical performance. Sufficient clearance should be designed on the PCB between the outer edges of the land pattern and the inner edges of pad pattern for the leads to avoid any shorts.

While the land pattern on the PCB provides a means of heat transfer and electrical grounding from the package to the board through a solder joint, thermal vias are necessary to effectively conduct from the surface of the PCB to the ground plane(s). The land pattern must be connected to ground through these vias. The vias act as “heat pipes”. The number of vias (i.e. “heat pipes”) are application specific and dependent upon the package power dissipation as well as electrical conductivity requirements. Thus, thermal and electrical

analysis and/or testing are recommended to determine the minimum number needed. Maximum thermal and electrical performance is achieved when an array of vias is incorporated in the land pattern. It is recommended to use as many vias connected to ground as possible. It is also recommended that the via diameter should be 12 to 13mils (0.30 to 0.33mm) with 1oz copper via barrel plating. This is desirable to avoid any solder wicking inside the via during the soldering process which may result in voids in solder between the exposed pad/slug and the thermal land. Precautions should be taken to eliminate any solder voids between the exposed heat slug and the land pattern. Note: These recommendations are to be used as a guideline only. For further information, refer to the Application Note on the *Surface Mount Assembly* of Amkor’s Thermally/Electrically Enhance Leadframe Base Package, Amkor Technology.



**FIGURE 10. ASSEMBLY FOR EXPOSED PAD THERMAL RELEASE PATH –SIDE VIEW (DRAWING NOT TO SCALE)**



## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the 843S06. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the 843S06 is the sum of the core power plus the analog power, plus the power dissipated in the load(s). The following is the power dissipation for  $V_{CC} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

**NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> =  $V_{CC\_MAX} * (I_{CC\_MAX} + I_{CCA\_MAX}) = 3.465V * (206.5mA + 8mA) = 743.2mW$
- Power (outputs)<sub>MAX</sub> = **30mW/Loaded Output pair**  
If all outputs are loaded, the total power is  $6 * 30mW = 180mW$

$$\text{Total Power}_{MAX} (3.465V, \text{ with all outputs switching}) = 743.2mW + 180mW = 923.2mW$$

### 2. Junction Temperature.

Junction temperature,  $T_j$ , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature is 125°C.

The equation for  $T_j$  is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

$T_j$  = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

$Pd\_total$  = Total Device Power Dissipation (example calculation is in section 1 above)

$T_A$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming no air flow and a multi-layer board, the appropriate value is 42.5°C/W per Table 7A below.

Therefore,  $T_j$  for an ambient temperature of 85°C with all outputs switching is:  
 $85^\circ C + 0.923W * 42.5^\circ C/W = 124.2^\circ C$ . This is below the limit of 125°C.

This calculation is only an example.  $T_j$  will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 7A. THERMAL RESISTANCE  $\theta_{JA}$  FOR 48-PIN LQFP, EDQUAD FORCED CONVECTION**

| $\theta_{JA}$ by Velocity (Linear Feet per Minute) |                                                   |
|----------------------------------------------------|---------------------------------------------------|
| Multi-Layer PCB, JEDEC Standard Test Boards        | <div style="text-align: center;">0</div> 42.5°C/W |

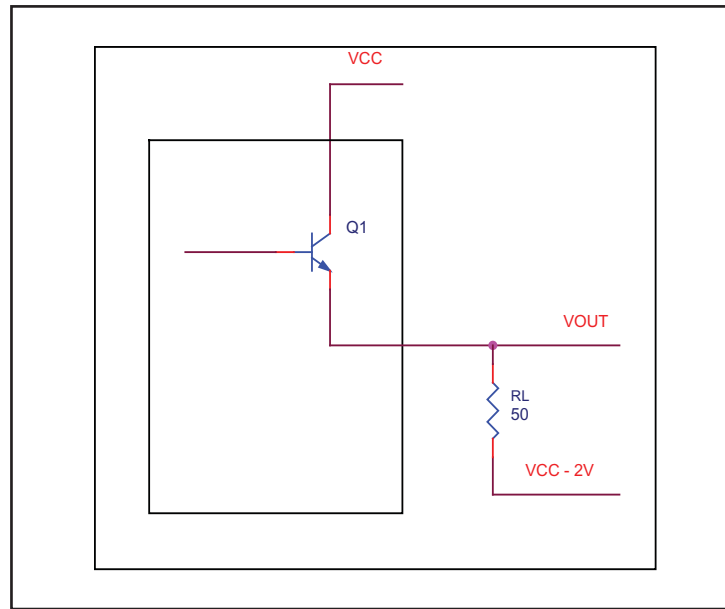
**TABLE 7B. THERMAL RESISTANCE  $\theta_{JA}$  FOR PROPOSED 48-PIN TQFP, E-PAD FORCED CONVECTION**

| $\theta_{JA}$ by Velocity (Meters per Second) |                                                   |                                                   |                                                     |
|-----------------------------------------------|---------------------------------------------------|---------------------------------------------------|-----------------------------------------------------|
| Multi-Layer PCB, JEDEC Standard Test Boards   | <div style="text-align: center;">0</div> 41.0°C/W | <div style="text-align: center;">1</div> 35.9°C/W | <div style="text-align: center;">2.5</div> 33.6°C/W |

### 3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in *Figure 11*.



**FIGURE 11. LVPECL DRIVER CIRCUIT AND TERMINATION**

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of  $V_{CC} - 2V$ .

- For logic high,  $V_{OUT} = V_{OH\_MAX} = V_{CC\_MAX} - 0.9V$

$$(V_{CC\_MAX} - V_{OH\_MAX}) = 0.9V$$

- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CC\_MAX} - 1.7V$

$$(V_{CC\_MAX} - V_{OL\_MAX}) = 1.7V$$

$Pd\_H$  is power dissipation when the output drives high.

$Pd\_L$  is the power dissipation when the output drives low.

$$Pd\_H = [(V_{OH\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CC} - V_{OH\_MAX}))/R_L] * (V_{CC} - V_{OH\_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = \mathbf{19.8mW}$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CC} - V_{OL\_MAX}))/R_L] * (V_{CC} - V_{OL\_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = \mathbf{10.2mW}$$

$$\text{Total Power Dissipation per output pair} = Pd\_H + Pd\_L = \mathbf{30mW}$$

## RELIABILITY INFORMATION

**TABLE 8A.  $\theta_{JA}$  VS. AIR FLOW TABLE FOR 48 LEAD LQFP, EQUAD**

| $\theta_{JA}$ by Velocity (Linear Feet per Minute) |                                                          |
|----------------------------------------------------|----------------------------------------------------------|
| Multi-Layer PCB, JEDEC Standard Test Boards        | <p style="text-align: center;"><b>0</b><br/>42.5°C/W</p> |

**TABLE 8B.  $\theta_{JA}$  VS. AIR FLOW TABLE FOR PROPOSED 48 LEAD TQFP, E-PAD**

| $\theta_{JA}$ by Velocity (Meters per Second) |                                                          |                                                          |                                                            |
|-----------------------------------------------|----------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------------|
| Multi-Layer PCB, JEDEC Standard Test Boards   | <p style="text-align: center;"><b>0</b><br/>41.0°C/W</p> | <p style="text-align: center;"><b>1</b><br/>35.9°C/W</p> | <p style="text-align: center;"><b>2.5</b><br/>33.6°C/W</p> |

### TRANSISTOR COUNT

The transistor count for 843S06 is: 10,264

### MTBF

25,470 years @ 60%  $C_L$ , 10,135 years @ 90%  $C_L$

**FIT will be closed after Rev. 1**

PACKAGE OUTLINE - Y SUFFIX FOR 48 LEAD TQFP, E-PAD

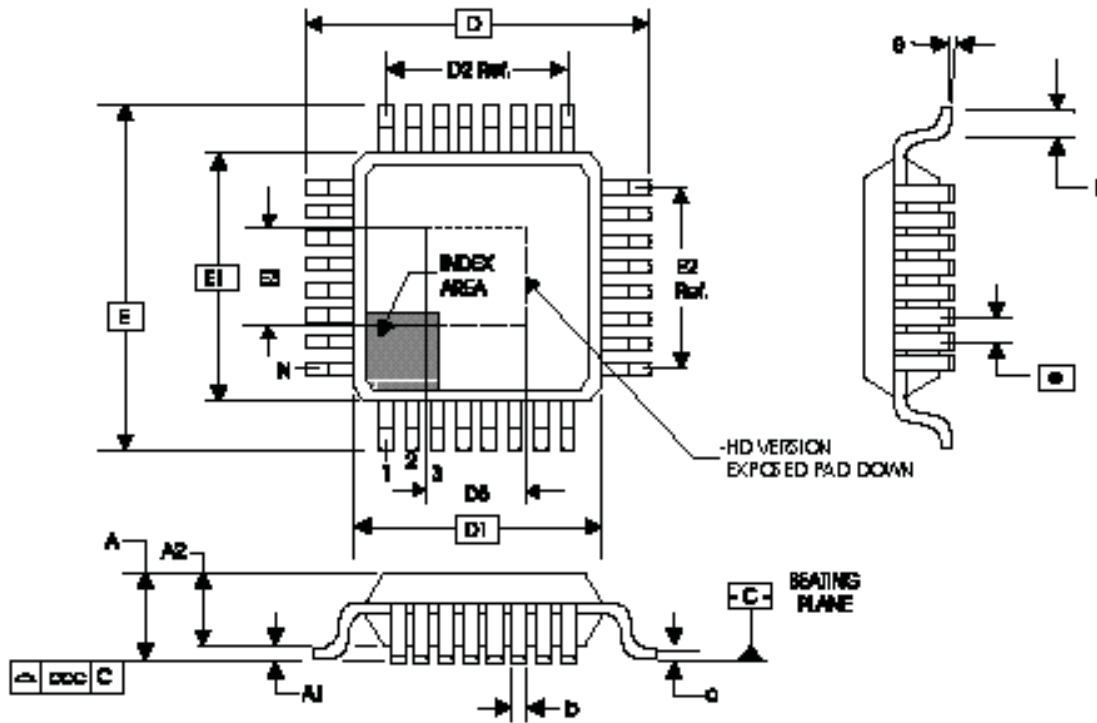


TABLE 9B. PACKAGE DIMENSIONS

| JEDEC VARIATION<br>ALL DIMENSIONS IN MILLIMETERS |            |         |         |
|--------------------------------------------------|------------|---------|---------|
| SYMBOL                                           | ABC - HD   |         |         |
|                                                  | MINIMUM    | NOMINAL | MAXIMUM |
| N                                                | 48         |         |         |
| A                                                | --         | --      | 1.20    |
| A1                                               | 0.05       | --      | 0.15    |
| A2                                               | 0.95       | 1.00    | 1.05    |
| b                                                | 0.17       | 0.22    | 0.27    |
| c                                                | 0.09       |         | 0.20    |
| D                                                | 9.00 BASIC |         |         |
| D1                                               | 7.00 BASIC |         |         |
| D2                                               | 5.50 BASIC |         |         |
| E                                                | 9.00 BASIC |         |         |
| E1                                               | 7.00 BASIC |         |         |
| E2                                               | 5.50 BASIC |         |         |
| e                                                | 0.5 BASIC  |         |         |
| L                                                | 0.45       | 0.60    | 0.75    |
| θ                                                | 0°         |         | 7°      |
| ccc                                              | --         | --      | 0.08    |
| D3 & E3                                          | 2.95       |         |         |

Reference Document: JEDEC Publication 95, MS-026

**TABLE 10. ORDERING INFORMATION**

| Part/Order Number | Marking      | Package                                  | Shipping Packaging | Temperature   |
|-------------------|--------------|------------------------------------------|--------------------|---------------|
| 843S06FYLF        | ICS843S06FYL | Proposed 48 Lead "Lead-Free" TQFP, E-Pad | Tray               | -40°C to 85°C |
| 843S06FYLFT       | ICS843S06FYL | Proposed 48 Lead "Lead-Free" TQFP, E-Pad | Tape & Reel        | -40°C to 85°C |

**TOP MARK INFORMATION**

|                                                     |
|-----------------------------------------------------|
| ICS<br>843S06FYL<br><Lot/Date Code><br><Lot Number> |
|-----------------------------------------------------|

| REVISION HISTORY SHEET |                   |            |                                                                                               |          |
|------------------------|-------------------|------------|-----------------------------------------------------------------------------------------------|----------|
| Rev                    | Table             | Page       | Description of Change                                                                         | Date     |
| 10                     | T8B<br>T9B<br>T10 | 1          | Added 48 TQFP, E-Pad package and information.                                                 | 1/7/09   |
|                        |                   | 19         | Added 48 TQFP, E-Pad Thermal information.                                                     |          |
|                        |                   | 21         | Added 48 Lead TQFP, E-Pad package outline and dimensions.                                     |          |
|                        |                   | 22         | Ordering Information Table - added 48 Lead TQFP, E-Pad part number and marking.               |          |
| 11                     | T7B<br>T9B<br>10  | 17         | Thermal Resistance Table - updated thermal numbers for new TQFP package.                      | 4/22/09  |
|                        |                   | 21         | TQFP Package Dimensions - updated D3 & E3 dimension.                                          |          |
|                        |                   | 22         | Ordering Information Table - changed TQFP revision from "E" to "F".                           |          |
| 11                     | 7B, 8B, 9B        | 1          | Deleted HiPerClockS references. Deleted "Proposed" from Pin Assignment.                       | 4/29/13  |
|                        |                   | 17, 19, 21 | Deleted "Proposed"                                                                            |          |
|                        |                   | 17         | Deleted HiPerClockS references.                                                               |          |
|                        |                   | 22         | Deleted "Proposed" from 2nd top mark info box                                                 |          |
| 11                     | T10               | 1, 20      | Removed 48 Lead LQFP EDQUAD package information.                                              | 10/23/15 |
|                        |                   | 21         | Ordering Information - removed 48 lead EDQUAD orderable part number and Top Mark information. |          |
|                        |                   |            | Updated data sheet format.                                                                    |          |



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